

RXO2213S

The RXO2213S is a radiation tolerant XO in 22 x 13 mm hermetically sealed package. This XO is specifically designed to meet the space missions where it is resistant to demanding environment, short lead-time and radiation tolerance requirements are important.

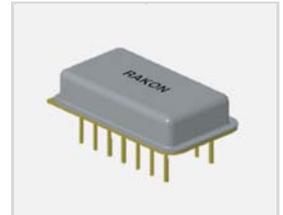
Features

- TID limit of 100 kRad and latch-up free till 32.4/62 MeV
- Hermetically sealed package
- Frequency range: 0.250 to 52.5 MHz
- Low current: 20 mA
- Supply voltage: 3.3 or 5.0 V
- ± 50 ppm over -55 to 125°C
- Manufactured in accordance with: MIL-PRL-55310 Class 2, level S

Applications

- Space applications such as Clocks
- Gyroscopes and Frequency Generation Units (FGU)

22 x 13 mm



Environmental Conditions

Parameter	Condition / Remarks	Min.	Typ.	Max.	Unit
Operating temperature		-25		85	°C
		-55		125	°C
Switch-on Temperature	TSo	-55		125	°C
Non-operating temperature	TNOp	-55		125	°C

Frequency Characteristics

Parameter	Condition / Remarks	Min.	Typ.	Max.	Unit
Initial frequency tolerance	@ 25°C			± 15	ppm
Frequency stability over temperature (FvT)	-25 to 85°C			± 25	ppm
	-55 to 125°C			± 50	ppm
Supply voltage stability (FvT) ¹	$\pm 5\%$ tolerance			± 2	ppm
Ageing	Per year @ 70°C			± 3	ppm
Start-up time				10	ms

Electrical Interface

Parameter	Condition / Remarks	Min.	Typ.	Max.	Unit
Power supply (Vcc)	$\pm 5\%$ tolerance		3.3, 5.0		V
Input current ¹	No load		20		mA

Output Characteristics HCMOS²

Parameter	Condition / Remarks	Min.	Typ.	Max.	Unit
Nominal frequency	HCMOS output	0.256		52.5	MHz
Output voltage (VoL) ¹	15 pF load			10% Vcc	V
Output voltage (VoH) ¹	15 pF load	90% Vcc			V
Duty cycle ¹	@50% Vcc	40		60	%
Rise time / Fall time ¹	10 % to 90% Vcc			10	ns

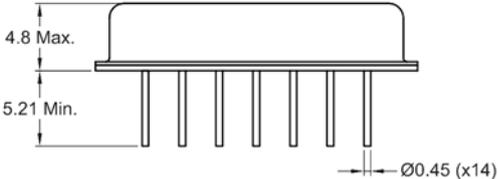
¹ Over operating temperature.

² Transistor Transistor Logic (TTL) output option available on request.

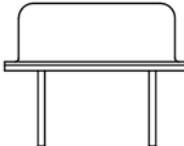
Screening (100%)

Screening Operation	Requirements and Condition
Non-destructive bond pull	MIL-STD-883, method 2023
Internal visual	MIL-STD-883, method 2017 and method 2032
Stabilization bake (prior to seal)	MIL-STD-883, method 1008, condition C (+150°C), 48 hours minimum
Thermal shock	MIL-STD-883, method 1011, condition A
Temperature cycling	MIL-STD-883, method 1010, condition C
Constant acceleration	MIL-STD-883, method 2001, condition A, Y1 only (5000 g's)
Seal (fine and gross leak)	MIL-STD-883, method 1014 Fine leak: Test condition A1, A2, or B Gross leak: Test condition B2 or B3
Particle impact noise detection (PIND)	MIL-STD-883, method 2020, condition A
Burn-in (load)	125°C, nominal supply voltage and burn-in load, 240 hours minimum
Electrical test	Nominal and extreme supply voltages, specified load, 23°C and temperature extremes, record all test parameters by serial number
Radiographic	MIL-STD-883, method 2012
External Visual	MIL-STD-883, method 2009

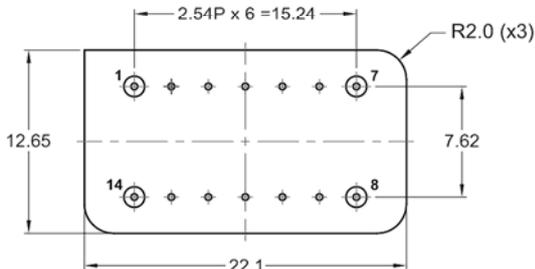
Model Outline, Pin Connections and Recommended Pad Layout



FRONT VIEW



SIDE VIEW



BOTTOM VIEW

Pin	Connections
1, 2, 3, 4, 5, 6	NC
7	GND
8	Fout (Frequency output)
9, 10, 11, 12, 13	NC
14	Vcc (Supply voltage)

NOTE:

- Dimensions are in millimetres.
- Tolerance is ±0.2 mm if it has not been indicated.